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from the INTERNATIONAL BUREAU

PCT

NOTIFICATION OF TRANSMITT TO TRANS OF COPIES OF TRANSLATION OF THE INTERNATIONAL PRELIMINARY **EXAMINATION REPORT**

(PCT Rule 72.2)

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TC 1700

Dat of mailing (day/month/year) 22 August 2001 (22.08.01)

Applicant's or agent's file reference

661504

International application No. PCT/JP00/00372

IMPORTANT NOTIFICATION

International filing date (day/month/year) 26 January 2000 (26.01.00)

Applicant

MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD. et al.

1. Transmittal of the translation to the applicant.

The International Bureau transmits herewith a copy of the English translation made by the International Bureau of the international preliminary examination report established by the International Preliminary Examining Authority.

2. Transmittal of the copy of the translation to the elected Offices.

The International Bureau notifies the applicant that copies of that translation have been transmitted to the following elected Offices requiring such translation:

EP,CN,US

The following elected Offices, having waived the requirement for such a transmittal at this time. will receive copies of that translation from the International Bureau only upon their request:

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3. Reminder regarding translation into (one of) the official language(s) of the elected Office(s).

The applicant is reminded that, where a translation of the international application must be furnished to an elected Office, that translation must contain a translation of any annexes to the international preliminary examination report.

It is the applicant's responsibility to prepare and furnish such translation directly to each elected Offic c ncern d (Rule 74.1). See V lume II f the PCT Applicant's Guide f r further d tails.

The Internati nal Bureau of WIPO 34, chemin des Col mbett s 1211 G neva 20, Switz rland

Authorized officer

Eliott PERETTI

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Form PCT/IB/338 (July 1996)

Translation



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TC 1700 IMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference 661504	FOR FURTHER ACTION		ionofTransmittalofInternational Preliminary Report (Form PCT/IPEA/416)			
International application No. PCT/JP00/00372	International filing date (day/r 26 January 2000 (26		Priority date (day/month/year) 29 January 1999 (29.01.99)			
International Patent Classification (IPC) or n H01L 21/60	· · · · · · · · · · · · · · · · · · ·					
Applicant MATSU	SHITA ELECTRIC INDU	STRIAL C	O., LTD.			
1. This international preliminary examination report has been prepared by this International Preliminary Examining Authority and is transmitted to the applicant according to Article 36. 2. This REPORT consists of a total of						
Date of submission of the demand	Date of	completion of	f this report			
31 May 2000 (31.05.			bruary 2001 (26.02.2001)			
Name and mailing address of the IPEA/JP	Author	ized officer				
Facsimile No.	Telepho	one No.				

International application No.

PCT/JP00/00372

I. Bas	is of the rep	port	
1. Wi	th regard to	the elements of the international application:*	
	the inter	mational application as originally filed	
\boxtimes	the desci	ription:	
	pages _	1-98	, as originally filed
	pages		, filed with the demand
,	pages _		, filed with the letter of
\boxtimes	the claim		
<u></u>	pages	1-45	, as originally filed
	pages		, as amended (together with any statement under Article 19
	pages		, filed with the demand
	pages _	46-49	, filed with the letter of 27 October 2000 (27.10.2000)
∇			
	the draw	_	on originally filed
	pages _	1-56	
	pages _ pages		, filed with the demand
	,		, filed with the letter of
L	the sequen	nce listing part of the description:	•
	pages _		, as originally filed
	pages _		, filed with the demand
	pages _		, filed with the letter of
The	the langu		ollowing language which is: ernational search (under Rule 23.1(b)).
3. Wi	th regard t	to any nucleotide and/or amino acid sequence of amination was carried out on the basis of the sequence	disclosed in the international application, the international
	containe	ed in the international application in written form.	•
<u></u>	filed tog	gether with the international application in computer re	adable form.
	furnished	ed subsequently to this Authority in written form.	•
	furnished	d subsequently to this Authority in computer readable	form.
	The stat	tement that the subsequently furnished written se ional application as filed has been furnished.	equence listing does not go beyond the disclosure in the
· <u></u>	The state		eadable form is identical to the written sequence listing has
4. [The ame	endments have resulted in the cancellation of:	
	th	he description, pages	·
		he claims, Nos.	1
		he drawings, sheets/fig	
5.	This repo		nts had not been made, since they have been considered to go I Box (Rule 70.2(c)).**
in t	placement sh this report of 170.17).	neets which have been furnished to the receiving Offic as "originally filed" and are not annexed to this	re in response to an invitation under Article 14 are referred to report since they do not contain amendments (Rule 70.16
** Any	replacemen	nt sheet containing such amendments must be referred	to under item 1 and annexed to this report.

International application No. PCT/JP 00/00372

V.	Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement

l. Staten	nent			· · · · · · · · · · · · · · · · · · ·
Nov	relty (N)	Claims	1-24,26,30-32,34-42,44-46	YES
		Claims	25,27-29,33,43,47-49	NO .
Inve	entive step (IS)	Claims	1-24,26,31,32,34-42,44-46	YES
	•	Claims	25,27-30,33,43,47-49	NO
Indu	strial applicability (IA)	Claims	1-49	_ YES
		Claims		NO
Citat	tions and explanations			<u>-</u>

- Document 1: JP, 8-222599, A (Mitsubishi Electric Corp.),
 August 30, 1996 (30.08.96)
- Document 2: JP, 10-308417, A (Oki Electric Industry Co., Ltd.), November 17, 1998 (17.11.98)
- Document 3: JP, 10-321669, A (Murata Mfg. Co., Ltd.),
 December 4, 1998 (04.12.98)
- Document 4: JP, 10-256306, A (Hitachi Chemical Co., Ltd.), September 25, 1998 (25.09.98)
- Document 5: JP, 5-70750, A (Fujitsu Ltd.), March 23, 1993 (23.03.93)
- Document 6: JP, 10-4097, A (Sharp Corp.), January 6, 1998 (06.01.98)
- Document 7: JP, 10-13002, A (Matsushita Electric Industrial Co., Ltd.), January 16, 1998 (16.01.98)
- Document 8: JP, 5-13119, A (Sharp Corp.), January 22, 1993 (22.01.93)
- Document 9: JP, 10-84014, A (Shinko Electric Industries Co., Ltd.), March 31, 1998 (31.03.98)

Document 10(addition): WO, 98-30073, A (Matsushita Electric Industrial Co., Ltd.),
July 9, 1998 (09.07.98)

Document 11(addition): JP, 2000-223534, A (Toshiba Corp.),

August 11, 2000 (11.08.00)

Claims 1 to 7, 10 to 17, 20, 22, 23 and 46

The invention disclosed in Claims 1 to 7, 10 to 17, 20, 22, 23 and 46 involves an inventive step in relation to Documents 1 to 9 cited in the international search report. Documents 1 to 9 do not disclose the feature wherein "the electronic component and the circuit substrate are joined together while placing an anisotropic conductive layer containing conductive particles within an insulating resin containing an inorganic filler".

Moreover, a person skilled in the art would not easily be able to conceive of this feature in the light of the disclosures in Documents 1 to 9.

Claims 8, 9, 31, 32 and 35

The invention disclosed in Claims 8, 9, 31, 32 and 35 involves an inventive step in relation to Documents 1 to 9 cited in the international search report. Documents 1 to 9 do not disclose the feature wherein "the insulating resin is hardened while strongly bending the substrate by applying pressure P1 and, after a predetermined amount of time has passed, the aforementioned pressure P1 is reduced to a weaker pressure P2." Moreover, a person skilled in the art would not easily be able to conceive of this feature in the light of the disclosures in Documents 1 to 9.

Claims 18, 19, 21, 24 and 37 to 42

The invention disclosed in Claims 18, 19, 21, 24 and 37 to 42 involves an inventive step in relation to Documents 1 to 9 cited in the international search report. Documents 1 to 9 do not disclose the feature of "an anisotropic layer having a section in which the amount of inorganic filler contained in the insulating resin is

small." Moreover, a person skilled in the art would not easily be able to conceive of this feature in the light of the disclosures in Documents 1 to 9.

Claims 25, 27, 29, 33, 43 and 47 to 49

The invention disclosed in Claims 25, 27, 29, 33, 43 and 47 to 49 lacks novelty over newly cited Document 10. The invention disclosed in Claims 25, 27, 29, 33, 43 and 47 to 49 is disclosed in Embodiments 1 and 2 of Document 10.

Claims 26, 28, 34, 44 and 45

The invention disclosed in Claims 26, 28, 34, 44 and 45 involves an inventive step in relation to Documents 1 to 9 cited in the international search report. Documents 1 to 9 do not disclose the feature of "preventing the neck section of the bump from collapsing by applying a load of 20gf or less to the bump." Moreover, a person skilled in the art would not easily be able to conceive of this feature in the light of the disclosures in Documents 1 to 9.

Claim 30

The invention disclosed in Claim 30 does not involve an inventive step in the light of newly cited Document 10 and Document 6. Fig. 1 of Document 6 indicates that α =45 and this is equivalent to the chamfer angle being 90°. It would be easy for a person skilled in the art to form the bumps in the invention disclosed in Document 10 using a capillary having this chamfer angle.

Claim 36

The invention disclosed in Claim 36 involves an inventive step in relation to Documents 1 to 9 cited in the international search report. Documents 1 to 9 do not

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disclose the feature of "several types of inorganic fillers which have different average particle diameters." Moreover, a person skilled in the art would not easily be able to conceive of this feature in the light of the disclosures in Documents 1 to 9.